

GSM2265RF

20V Dual P-Channel MOSFETs

Product Description

These P-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode.

These devices are well suited for high efficiency fast switching applications.

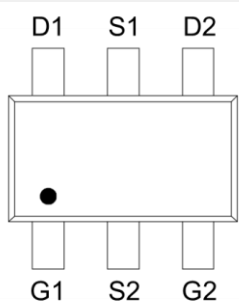
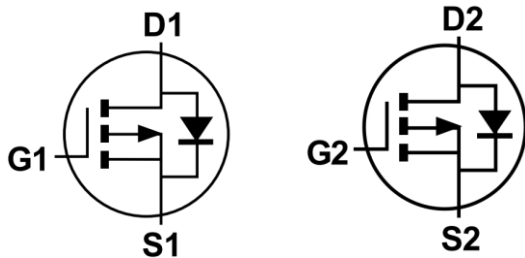
Features

- $R_{DS(ON)}=65m\Omega@V_{GS}=-4.5V$
- $R_{DS(ON)}=85m\Omega@V_{GS}=-2.5V$
- $R_{DS(ON)}=130m\Omega@V_{GS}=-1.8V$
- Improved dv/dt capability
- Fast switching
- Suit for -1.8V Gate Drive Applications
- SOT-23-6L package design

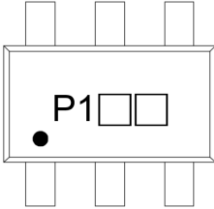
Applications

- Notebook
- Load Switch
- Hand-held Instruments

Packages & Pin Assignments

SOT-23-6L		Equivalent Circuit	
 <p>Top View</p>			
Pin	Description	Pin	Description
1	Gate 1	4	Drain 2
2	Source 2	5	Source 1
3	Gate 2	6	Drain 1

Ordering and Marking Information

Ordering Information			
Part Number	Package	Part Marking	Quantity / Reel
GSM2265RF	SOT-23-6L	P1□□	3,000 PCS
GSM2265 1 2			
- Product Code: GSM2265		- Package Code: 1 is R for SOT-23-6L	
		- Green Level: 2 is F for RoHS Compliant and Halogen Free	
Marking Information			
		- Product Code: P1	
		- GS Code: □□	

Absolute Maximum Ratings (T_A=25°C, unless otherwise specified)

Symbol	Parameter	Value	Unit
V _{DSS}	Drain-Source Voltage	-20	V
V _{GSS}	Gate-Source Voltage	±12	V
I _D	Continuous Drain Current	T _A =25°C	-3.7
		T _A =70°C	-2.9
I _{DM}	Pulsed Drain Current ¹	-14	A
P _D	Total Power Dissipation	T _A =25°C	1.25
		T _A =70°C	0.8
T _J	Operating Junction Temperature Range	-55 to +150	°C
T _{STG}	Storage Temperature Range	-55 to +150	°C
R _{θJA}	Thermal Resistance, Junction to Ambient	100	°C/W

Note:

1. Repetitive Rating: Pulsed width limited by maximum junction temperature.

Electrical Characteristics (T_A=25°C, unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Static characteristics						
B _V DSS	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =-250μA	-20	-	-	V
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =-250μA	-0.4	-	-0.9	V
I _{GSS}	Gate-Source Leakage Current	V _{DS} =0V, V _{GS} =±12V	-	-	±100	nA
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =-20V, V _{GS} =0V	-	-	-1	μA
R _{DS(on)}	Drain-Source On-Resistance	V _{GS} =-4.5V, I _D =-4.5A	-	52	65	mΩ
		V _{GS} =-2.5V, I _D =-3A	-	72	85	
		V _{GS} =-1.8V, I _D =-1.5A	-	100	130	
g _{FS}	Forward Transconductance	V _{DS} =-5V, I _D =-4.5A	-	11	-	S
V _{SD}	Diode Forward Voltage	V _{GS} =0V, I _S =-1A	-	-0.8	-1.2	V
Dynamic characteristics						
C _{iss}	Input Capacitance	V _{DS} =-10V, V _{GS} =0V, f=1MHz	-	515	-	nC
C _{oss}	Output Capacitance		-	55	-	
C _{rss}	Reverse Transfer Capacitance		-	20	-	
Q _g	Total Gate Charge ^{2,3}	V _{DS} =-10V, V _{GS} =-4.5V, I _D =-3A	-	6.4	-	pF
Q _{gs}	Gate-Source Charge ^{2,3}		-	0.9	-	
Q _{gd}	Gate-Drain Charge ^{2,3}		-	1.6	-	
t _{d(on)}	Turn-On Delay Time ^{2,3}	V _{DD} =-10V, I _D =-1A, V _{GS} =-4.5V, R _G =25Ω	-	5	-	ns
t _r	Turn-On Rise Time ^{2,3}		-	17.4	-	
t _{d(off)}	Turn-Off Delay Time ^{2,3}		-	40.7	-	
t _f	Turn-Off Fall Time ^{2,3}		-	11.4	-	

Note:

2. The data tested by pulsed, pulse width ≤ 300us, duty cycle ≤ 2%.
3. Essentially independent of operating temperature.

Typical Performance Characteristics

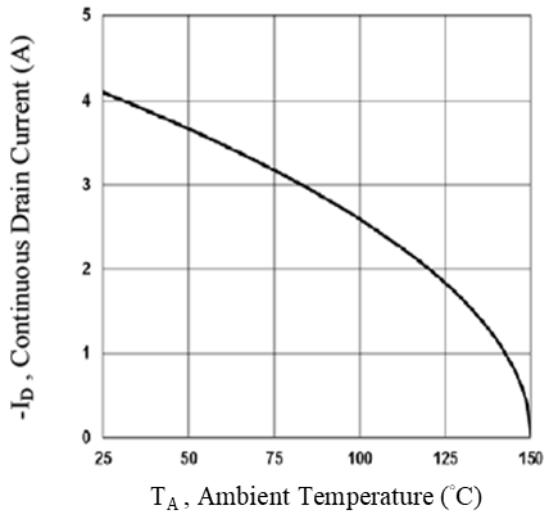


Fig.1 Continuous Drain Current vs T_A

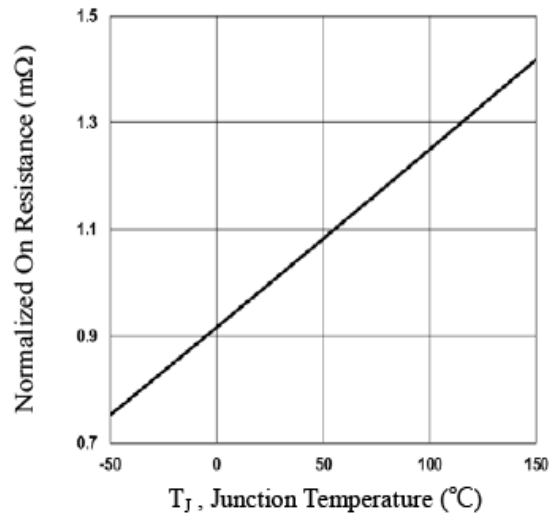


Fig.2 Normalized $R_{DS(ON)}$ vs T_J

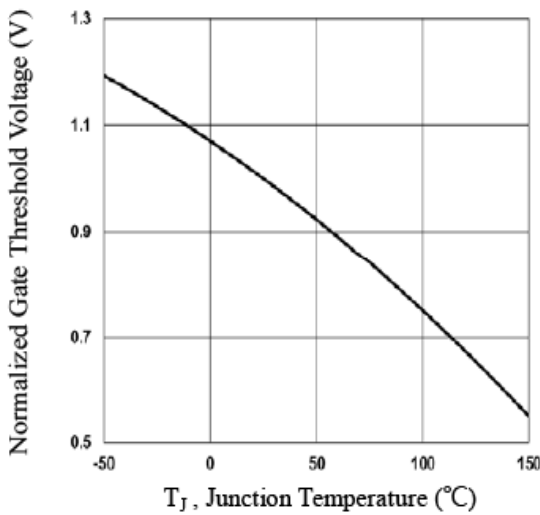


Fig.3 Normalized $V_{GS(th)}$ vs T_J

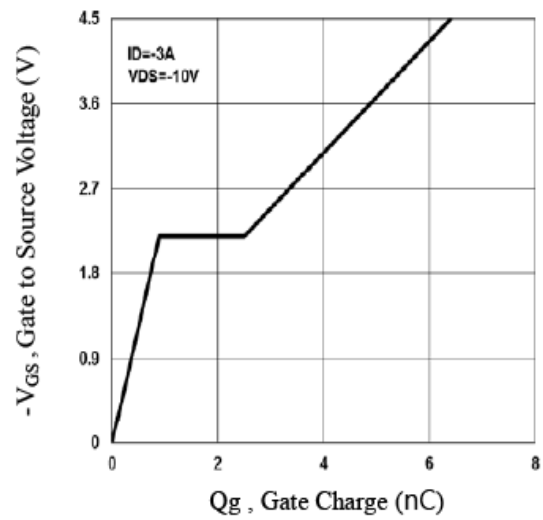


Fig.4 Gate Charge

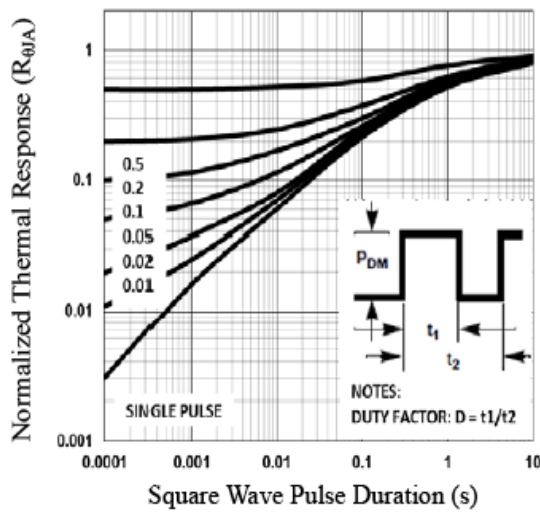


Fig.5 Normalized Transient Impedance

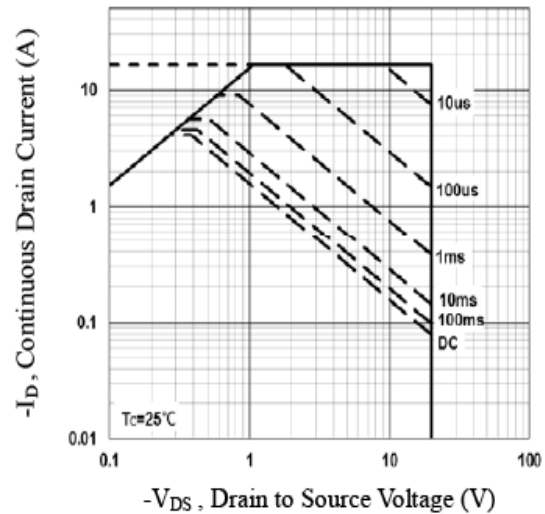
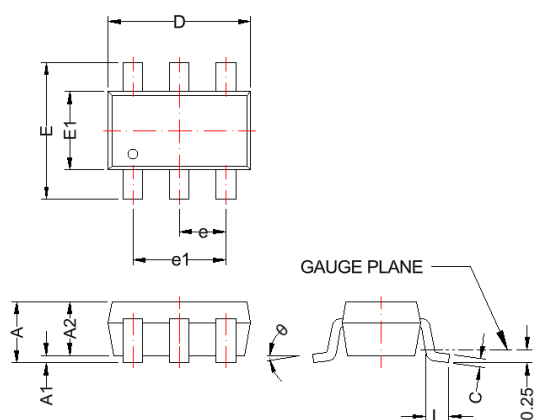
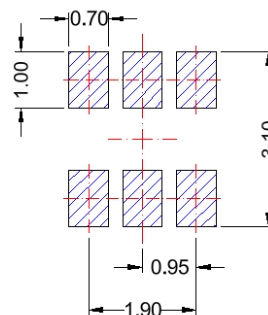


Fig.8 Maximum Safe Operating Area

Package Dimension



Recommended Land Pattern



Unit:mm





Dimensions				
Symbol	Millimeters		Inches	
	Min	Max	Min	Max
A	0.90	1.45	0.035	0.057
A1	0.00	0.15	0.000	0.006
A2	0.90	1.30	0.035	0.051
b	0.30	0.50	0.012	0.020
c	0.08	0.26	0.003	0.010
D	2.70	3.10	0.106	0.122
E	2.20	3.00	0.087	0.118
E1	1.30	1.75	0.051	0.069
e	0.95 BSC		0.037 BSC	
e1	1.90 BSC		0.075 BSC	
L	0.30	0.60	0.012	0.024
θ	0°	8°	0°	8°



Note:
Dimensions are exclusive of Burrs, Mold Flash & Tie Bar extrusions.

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